

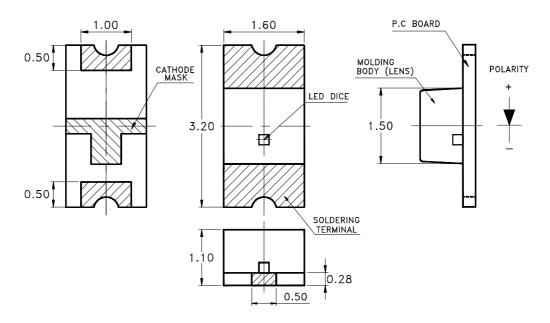
### **Features**

- 3.2mm\*1.6mm SMT LED, Super thin (1.1H mm)
- Low Power Consumption
- Wide Viewing Angle
- Various Colors
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow and wave solder process.
- Meet ROHS Green Products
- Package: 3000pcs/Reel

## **Applications**

· Backlight and Indicator

### **Package Dimensions**



### **Notes:**

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2$ mm (.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

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### **FSL-3216110R-RDBNC3**

### **Selection Guide**

Part No	Lens Type	Dice	Emitted Color
FSL-3216110R-RDBNC3	Water Clear	AllnGap	Red

### Electrical / Optical Characteristics At Ta=25°C

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Condition
Iv	Luminous Intensity	28	72		mcd	IF=20mA
201/2	Viewing Angle		130		deg	IF=20mA
入 Peak	Peak Emission Wavelength		639		nm	IF=20mA
入 d	Dominant Wavelength		631		nm	IF=20mA
$\triangle \lambda$	Spectral Line Half-Width		20		nm	IF=20mA
VF	Forward Voltage	1.7	2.2	2.6	V	IF=20mA
IR	Reverse Current			10	μА	VR 5V

Note:

# **Absolute Maximum Ratings At Ta=25℃**

Parameter	Red	Unit
Power Dissipation	75	mW
Peak Forward Current[1]	80	mA
Continuous Forward Current	30	mA
Dreading Linear From25°C	0.4	mA/°C
Reverse Voltage	5	V
Electrostatic Discharge Threshold(HBM)	2000 V	
Operating Temperature Range	-55°C to + 85°C	
Storage Temperature Range	-55°C to + 85°C	
Soldering Condition	260°C For 5 Seconds	

Note:

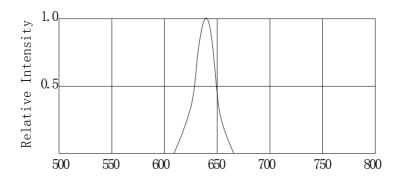
1. 1/10DutyCycle, 0.1msPulseWidth

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 $<sup>1.\,\</sup>theta1/2$  is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value



### Electrical Optical Characteristics Curves At Ta=25°C



Wavelength  $\lambda$  (nm)

Fig. 1 Relative Intensity vs. Wavelength

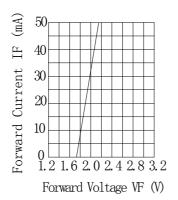


Fig. 2 Forward Current VS. Forward Voltage

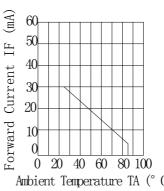
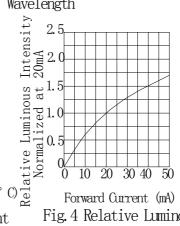
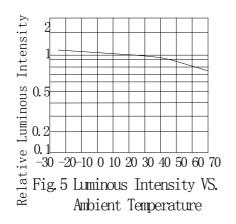


Fig. 3 Forward Current Derating Curve



Forward Current (mA)
Fig. 4 Relative Luminous
Intensity VS. Forward
Current



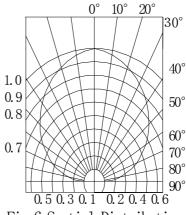


Fig. 6 Spatial Distribution

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### **FSL-3216110R-RDBNC3**

# **Bin Range Of Luminous Intensity**

Symbol	Bin Code	Min.	Max.	Unit	Condition
	N	28	45		
	P	45	72		
Iv	Q	72	112	mcd	IF=20mA
	R	112	180		
	S	180	280		

# **Bin Range Of Forward Voltage**

Symbol	Bin Code	Min.	Max.	Unit	Condition
	V2	1.7	2.0		
VF	V3	2.0	2.3	V	IF=20mA
	V4	2.2	2.6		

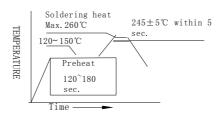
### Notes:

- 1. Tolerance of Luminous Intensity +/-20 %
- 2. Tolerance of Forward Voltage  $\pm -0.2V$
- 3. Tolerance of the Dominate Wavelength +/- 2nm

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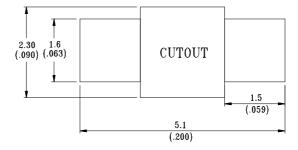
### **SMT Reflow Soldering Instructions**



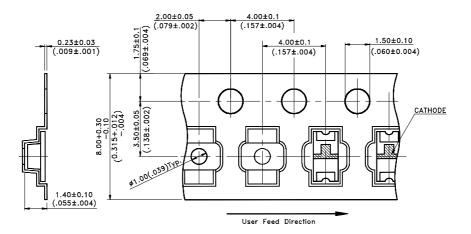
#### Notes:

- Sells gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- Do not stress LED when soldering, and do not warp the circuit board after soldering
- While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

### **Recommended Soldering Pad Dimensions**



### Package Specifications (Units: mm (inches))



### Notes:

- The LEDs should be used within a year.
- The LEDs should be kept in 5~30°C and 60% RH for less.
- The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

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### **Reliability Test Items Conditions**

Classification	Test Item	Test Conditions	Test hours	Result
	Opertion Life	Connect with a power if=20mA Ta=Under room temperature	1000Hrs	0/20
	Hige Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	Hige Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
Temperature Cycling		-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C~±5°C~+85°C~±5°C 5min 10sec 5min	300 Cycles	0/20
Test	Solder Resistance	Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

# Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V <sub>F</sub> (V)	IF=20mA	Over U×1.2
Rvevrse current	$I_R(\mu A)$	V <sub>R</sub> =5V	Over U×2
Luminous intensity	Iv(mcd)	IF=20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

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